80 AMP MINIATURE POWER RELAY

FEATURES

- 80 Amp switching capability
- Contact gap: >2.05 mm
- Holding power : <100 mW
- ullet Dielectric strength 5 kV_{RMS}
- Isolation spacing greater than 10 mm
- Double insulation, EN 60730-1 (VDE 0631, part 1)
- Reinforced insulation, EN 60335-1 (VDE 0700, part 1)
- UL / CUR E44211
- VDE 40044305

CONTACTS

• CQC 17002162259



GENERAL DATA



CONTACTS				
Arrangement	SPST (1 Form A)			
Ratings (max.) switched power switched current continuous current switched voltage	(resistive load) 22160 VA 80 A 80 A 150VDC* or 440VAC *Note: If switching voltage is greater than 30 VDC, special precautions must be taken. Please contact the factory.			
Rated Loads	80 A at 277 VAC, resistive, 1k cycles, 85℃			
VDE	30 A at 263 VAC, AC-7a, 30k cycles, 85 c			
UL/CUR	80 A at 277 VAC, resistive, 1k cycles			
CQC	80 A at 380 VAC, resistive, 1k cycles, 85°C 30 A at 380 VAC, resistive, 30k cycles, 85°C			
Contact material	AgSnO ₂ (silver tin oxide)			
Contact gap	2.05 mm			
Contact resistance initial	(at 6V 1A voltage drop method) ≤ 50 mΩ			
COIL				
Nominal coil DC voltages	12, 24			
Dropout voltage	> 5% of nominal coil voltage			
Coil power at pickup voltage Max. Continuous Dissipation	(at 20 °C) 270 mW 2.0 W at 20°C(68°F) ambient			
Temperature Rise	15°C(27°F) at nom. coil voltage			

Class F insulation - 155°C (311°F)

Life Expectancy mechanical electrical	(minimum operations) 1 x 10 ⁵ see UL/CUR/VDE/CQC ratings		
Operate Time	40 ms (max.) at nominal coil voltage		
Release Time	5 ms (max.) at nominal coil voltage, without coil suppression		
Dielectric Strength coil to load contacts open load contacts	(at sea level for 1 min.) 5000 V _{RMS} 2500 V _{RMS}		
Insulation (according to DIN VDE 0110,IEC 60664-1)	C250 Overvoltage category: III Pollution degree: 3 Nominal voltage: 250 VAC		
Insulation Resistance	1000 MΩ (min.) at 20°C, 500 VDC, 50% RH		
Temperature Range operating	(at nominal coil voltage) -40°C (-40°F) to 85°C (185°F)		
Vibration resistance	0.062" (1.5 mm) DA at 10–55 Hz		
Shock	10 g		
Enclosure	PA		
Terminals	Tinned copper alloy, P. C.		
Soldering max. temperature max. time	270 °C(518°F) 5 s		
Dimensions length width height	40.0 mm (1.57") 25.0 mm (0.98") 49.2 mm (1.94")		
Weight	105grams (approx.)		
Compliance	UL 508, IEC 61810-1, RoHS, REACH		
Packing unit in pcs	10 per plastic tubing / 100 per carton box		



Max. temperature

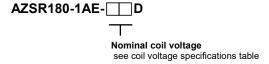
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COIL VOLTAGE SPECIFICATIONS

Nominal Coil VDC	Must Operate VDC	Min. Holding VDC	Max. Cont. VDC	Resistance Ohm ± 10%
12	9.0	4.0	24.0	300
24	18.0	8.0	48.0	1200

Note: All values at 20°C (68°F), upright position, terminals downward.

ORDERING DATA

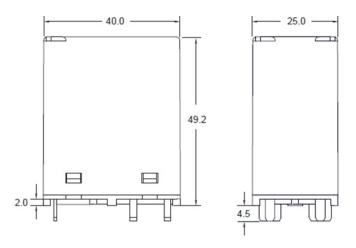


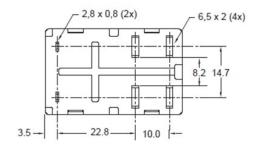
Example ordering data

AZSR180-1AE-24D With 24 VDC coil

MECHANICAL DATA

Dimensions in mm. Tolerance: ±0.25mm

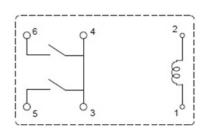




WIRING DIAGRAMS

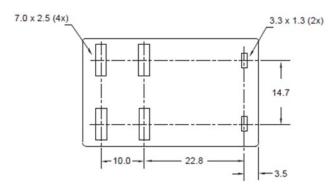
Viewed towards terminals

It is absolute necessary to provide a connection between pin 3 and 4 (5 and 6) on the PCB to avoid a malfunction of the relay! Check also note 4 on first page, please.



PC BOARD LAYOUT

Viewed towards terminals. Dimensions in mm.



NOTES

General

- All values in this datasheet are at reference temperature of 23°C (73°F) unless stated otherwise.
- 2. Evaluate the component's performance and operating conditions under the worst-case conditions of the actual application.
- 3. The datasheet and the component's specifications are subject to change without notice.

Storage, handling, and environmental guidelines

- 4. Relays are electromechanical components that are sensitive to shock. The relay's adjustment can be affected if the relay is subjected to excessive shock or excessive pressure is applied to the relay case. Relays which have been dropped must no longer be used.
- 5. Substances containing silicone o r phosphorus must be avoided in the vicinity to the relay. Outgassing from these substances can penetrate the relay and adhere on the contacts. Deposits of these substances may act as insulators and adversely affect the contact resistance. Silicone can be found e.g. in gaskets, lubricants or filling materials, phosphorus can be found e.g. as a flame retardant in plastics.
- Prevent relays from atmospheres containing corrosive gases or liquid or solid. Corrosion of structures and contacts leads to malfunction and shortens the component's service life.
- Prevent non-sealed relays from atmospheres subject to dust. Dust particles may enter the case and get stuck between the contacts, causing the contact circuits to fail.
- 8. Do not use these relays in environments with explosive or flammable gases. Electrical arcing at the contacts could ignite these gases and cause fire.
- 9. For automated dual wave soldering process we recommend preheating with 120°C (248°F) for max. 120 seconds and a soldering temperature of 260 ±5°C (500 ±9°F) for max. 10 seconds soldering time (max. 5 seconds per wave). For manual soldering we recommend 350°C (662°F) max. temperature for max. 5 seconds. During the soldering process, no force may be exerted on the relay terminals.
- 10. Non-sealed relays (RTII) must not be washed, immersion cleaned or conformal coated as substances may enter the case and cause corrosion or seizure of mechanical parts.
- 11. Avoid high frequency or ultrasonic vibrations on the relays as these can cause contact welding and misalignment or destruction of internal structures.
- 12. During operation, storage and transport, ambient temperature should be within the specified operating temperature range. Humidity should be in the range of 5% to 85% RH. Icing and condensation must be avoided. Relays stored for an extended period of time may show initially increased contact resistance values due to chemical effects such as oxidation.

Design guidelines

- 13. The relay may pull in and operate with less than the specified must operate voltage value.
- 14. The coil's *must operate* and *min. holding* voltages, the coil's *ohmic resistance* and the relay's *operate time* depend on the temperature of the coil. The specified values are given for a coil temperature of 23°C and increase by approx. 0.39% per Kelvin of temperature rise. This circumstance must be considered, especially during operation with high load currents and elevated ambient temperature.
- 15. At elevated ambient temperatures, after applying the rated nominal coil voltage for ≥ 200 milliseconds, the coil energization must be reduced to a suitable holding level in order to reduce thermal stress and to prevent the coil from overheating.
- 16. Coil suppression circuits such as diodes, etc. in parallel to the coil will lengthen the release time. We recommend using suppression circuits with a breakdown voltage of approx. 2 times the nominal coil voltage in order to achieve a quick release time.
- 17. When using PWM coil control, use a fast-switching recirculation diode in parallel with the coil to keep the coil current during pulse pauses. To achieve a quick release time when de-energizing the coil, the recirculation diode must be eliminated from the circuit to get a fast decay of coil current. As PWM frequency we recommend ≥ 15 kHz in order to avoid audible noise from magnetostriction. To reduce negative EMI effects, we recommend to apply the PWM to the coil's inner/center layer terminal and have the outer layer terminal connected to ground or the supply rail.
- 18. Contact resistance is a function of load current, dwell time and wear level of the contacts. Immediately after closing the contacts, or if tested with low current only, the contact resistance will show a relatively high value. A low level steady state contact resistance is reached at higher current after a certain time in thermal equilibrium.
- 19. The relay dissipates heat form power losses through its load terminals. Provide sufficient cross section and area of the PCB traces so that they can act as heat spreader.
- 20. For PCBs with multiple relays, do not place the components directly next to each other. We suggest providing a mounting distance of minimum 10 mm to allow for better cooling.
- 21. A minimum load of 10 mA / 5 V / 50 mW is recommended for the gold plated NC signal contact to ensure a reliable and stable electrical connection.
- 22. As with any contact mechanism, the relay's NC signal contact bounces when switching. For evaluation of its signal, suitable debouncing measures must be taken to get a reliable signal.

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DISCLAIMER

This product specification is to be used in conjunction with the application notes which can be downloaded from the regional ZETTLER relay websites. The specification provides an overview of the most significant part features. Any individual applications and operating conditions are not taken into consideration. It is recommended to test the product under application conditions. Responsibility for the application remains with the customer. Proper operation and service life cannot be guaranteed if the part is operated outside the specified limits.

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